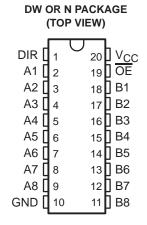
SN74ALS638A, SN74ALS639A, SN74AS638A, SN74AS639 OCTAL BUS TRANSCEIVERS

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- Choice of True or Inverting Logic
- A-Bus Outputs Are Open Collector;
 B-Bus Outputs Are 3 State
- Package Options Include Plastic Small-Outline (DW) Packages and Standard Plastic (N) 300-mil DIPs

DEVICE	A OUTPUT	B OUTPUT	LOGIC
SN74ALS638A, SN74AS638A	Open collector	3 state	Inverting
SN74ALS639A, SN74AS639	Open collector	3 state	True



description

These octal bus transceivers are designed for asynchronous two-way communication between open-collector and 3-state buses. The devices transmit data from the A bus (open-collector) to the B bus (3 state) or from the B bus to the A bus, depending on the logic level at the direction-control (DIR) input. The output-enable (\overline{OE}) input can be used to disable the device so the buses are isolated.

The -1 version of SN74ALS638A is identical to the standard version, except that the recommended maximum I_{OL} is increased to 48 mA.

The SN74ALS638A, SN74ALS639A, SN74AS638A, and SN74AS639 are characterized for operation from 0°C to 70°C.

FUNCTION TABLE

ı	INP	UTS	OPER.	ATION
	ŌĒ	DIR	SN74ALS638A SN74AS638A	SN74ALS639A SN74AS639
ı	L	L	B data to A bus	B data to A bus
	L	Н	A data to B bus	A data to B bus
	Н	Χ	Isolation	Isolation

logic symbols†

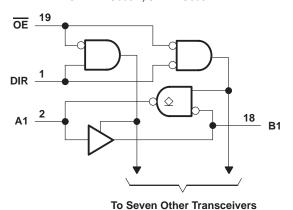
SN74ALS638A, SN74AS638A SN74ALS639A, SN74AS639 19 OE OE G3 G3 DIR 3 EN1 [BA] DIR 3 EN1 [BA] 3 EN2 [AB] 3 EN2 [AB] 18 18 **∆1 B**1 **∆1** ◁ **B**1 \triangleleft 2▽ 17 17 3 B2 B2 16 4 16 В3 **A3 B3** 5 15 5 15 **B4** B4 6 14 6 14 Α5 **B5 A5 B5** 7 13 13 **A6 B6 A6 B6** 8 12 8 12 **B7 B7** Α7 9 11 9 11 **B8 B8 8**A **A8**

To Seven Other Transceivers

logic diagrams (positive logic)

SN74ALS638A, SN74AS638A OE 18

SN74ALS639A, SN74AS639



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC} 7 V
Input voltage, V _I : All inputs 7 V
A-bus I/O ports 7 V
B-bus I/O ports 5.5 V
Operating free-air temperature range, T _A : SN74ALS638A, SN74ALS639A
Storage temperature range –65°C to 150°C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.



[†] These symbols are in accordance with ANSI/IEEE Std 91-1984 and IEC Publication 617-12.

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

recommended operating conditions

				N74ALS6 N74ALS6		UNIT
			MI	NOM	MAX	
Vcc	Supply voltage		4.	5 5	5.5	V
VIH	High-level input voltage		2		V	
V _{IL} Low-level input voltage					0.8	V
Vон	High-level output voltage	A ports			5.5	V
IOH	High-level output current	B ports			-15	mA
lo.	A se D a set				24	mA
IOL	Low-level output current	A or B ports			48†	IIIA
TA	Operating free-air temperature)	70	°C

[†] Applies only to the SN74ALS638A-1 version and only if V_{CC} is between 4.75 V and 5.25 V

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDI	TIONS	SN74ALS638A SN74ALS639A			UNIT	
				MIN	TYP‡	MAX		
٧ıK		$V_{CC} = 4.5 V,$	$I_{I} = -18 \text{ mA}$			-1.5	V	
loh	A ports	$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA	
		$V_{CC} = 4.5 \text{ V to } 5.5 \text{ V},$	$I_{OH} = -0.4 \text{ mA}$	V _{CC} -2	!			
Vон	B ports	V-2-45V	$I_{OH} = -3 \text{ mA}$	2.4	3.2		V	
		$V_{CC} = 4.5 V$	$I_{OH} = -15 \text{ mA}$	2				
			I _{OL} = 12 mA		0.25	0.4		
VOL	A or B ports	V _{CC} = 4.5 V	I _{OL} = 24 mA		0.35	0.5	V	
			I _{OL} = 48 mA [†]		0.5]		
	Control inputs	V 55V	V _I = 7 V			0.1	^	
ll .	A or B ports	$V_{CC} = 5.5 V$	V _I = 5.5 V			0.1	mA	
	Control inputs	V 55V				20	^	
lН	A or B ports§	$V_{CC} = 5.5 V,$	V _I = 2.7 V			20	μΑ	
	Control inputs	V 55V	V 0.4V			-0.1	0	
ΙIL	A or B ports§	$V_{CC} = 5.5 V,$	V _I = 0.4 V			-0.1	mA	
IOI	B ports	V _{CC} = 5.5 V,	V _O = 2.25 V	-30		-112	mA	
			Outputs high		18	30		
	SN74ALS638A	$V_{CC} = 5.5 V$	Outputs low		26	20 μA -0.1 mA -112 mA 30 41		
			Outputs disabled		16	30		
ICC			Outputs high	utputs high		40	mA	
	SN74ALS639A	SN74ALS639A $V_{CC} = 5.5 \text{ V}$ Outputs	Outputs low		30	50		
			Outputs disabled		33	54		

[†] Applies only to the SN74ALS638A-1 version and only if V_{CC} is between 4.75 V and 5.25 V



[‡] All typical values are at V_{CC} = 5 V, T_A = 25°C. § For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, IOS.

SN74ALS638A, SN74ALS639A, SN74AS638A, SN74AS639 OCTAL BUS TRANSCEIVERS

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	C _L = 50 R _L = 68 R1 = R	30 Ω (A	outputs), Ω (B outpi	uts),	UNIT
			SN74AL	S638A	SN74AL	S639A	
			MIN	MAX	MIN	MAX	
^t PLH	А	_	2	12	2	12	ns
^t PHL	A	В	2	12	2	12	113
t _{PLH}	В	Δ.	8	25	10	30	ns
^t PHL	В	А	8	30	5	22	115
^t PLH			5	25	10	30	ns
^t PHL	ŌĒ	А	10	45	10	35	110
^t PZH			5	20	6	21	
t _{PZL}	ŌĒ	В	5	22	8	25	ns
^t PHZ	ŌĒ	В	2	10	2	10	nc
t _{PLZ}	OE .	D	3	15	3	16	ns

[†] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)‡

Supply voltage, V _{CC}	
Input voltage, V _I : All inputs	7 V
A-bus I/O ports	
B-bus I/O ports	5.5 V
Operating free-air temperature range, T _A : SN74AS638A, SN74AS639	0°C to 70°C
Storage temperature range	-65° C to 150° C

[‡] Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

recommended operating conditions

				74AS638 174AS63		UNIT
			MIN	NOM	MAX	
Vcc	Supply voltage		4.5	5	5.5	V
VIH	High-level input voltage		2			V
V _{IL}	Low-level input voltage				0.8	V
Vон	High-level output voltage	A ports			5.5	V
ІОН	High-level output current	B ports			-15	mA
l _{OL}	Low-level output current	A or B ports			64	mA
TA	Operating free-air temperature		0		70	°C

SDAS123A - DECEMBER 1983 - REVISED JANUARY 1995

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

PARAMETER		TEST CONDIT	TIONS	SN74AS SN74A			UNIT
				MIN	TYP [†]	MAX	
٧ıK		V _{CC} = 4.5 V,	I _I = -18 mA			-1.2	V
loh	A ports	$V_{CC} = 4.5 V,$	V _{OH} = 5.5 V			0.1	mA
		V _{CC} = 4.5 V to 5.5 V, I _{OH}		VCC -2	<u>)</u>		
Vон	V_{OH} B ports $V_{CC} = 4.5 \text{ V}$		IOH = -3 mA	2.4	3.2		V
			$I_{OH} = -15 \text{ mA}$	2.4			
VOL	A or B ports	$V_{CC} = 4.5 V,$	I _{OL} = 64 mA		0.35	0.55	V
1.	Control inputs	V FFV	V _I = 7 V			0.1	A
'1	A or B ports	$V_{CC} = 5.5 \text{ V}$	V _I = 5.5 V			0.1	mA
1	Control inputs	V 55V	V: 0.7.V			20	A
ΊΗ	A or B ports‡	$V_{CC} = 5.5 \text{ V},$	V _I = 2.7 V		70		
1	Control inputs	V 55V	V: 0.4.V			-0.5	A
¹ı∟	A or B ports [‡]	$V_{CC} = 5.5 V$	V _I = 0.4 V			-0.75	mA
IO§		V _{CC} = 5.5 V,	V _O = 2.25 V	-50		-150	mA
			Outputs high		24	54	
	SN74AS638A	V _{CC} = 5.5 V	Outputs low		75	122	
			Outputs disabled		37	61	μA - mA - mA
Icc			Outputs high		56	92	IIIA
	SN74AS639	V _{CC} = 5.5 V	Outputs low		95	154	
			Outputs disabled		62	100	

switching characteristics (see Figure 1)

PARAMETER	FROM (INPUT)	TO (OUTPUT)	R1 = R2 T _A = MI	pF, 0 Ω (A α 2 = 500 Ω N to MA	outputs), 2 (B outp X¶	outs),	UNIT
			SN74A		SN74A		
			MIN	MAX	MIN	MAX	
^t PLH	Α	В	2	7	2	9.5	ns
^t PHL	7	В	2	6.5	2	9	115
tpLH	В		5	20	5	22	ns
t _{PHL}	Ь	A	2	7	2	9	115
tPLH	<u>OE</u>	Δ.	5	19	5	21.5	ns
^t PHL	ÜE	А	2	9	2	11.5	115
^t PZH	ŌĒ		2	8	2	10.5	20
tPZL	ÜE	В	2	10	2	10.5	ns
^t PHZ	ŌĒ	В	2	7	2	7	ne
t _{PLZ}	OE .	٥	2	10	2	10.5	ns

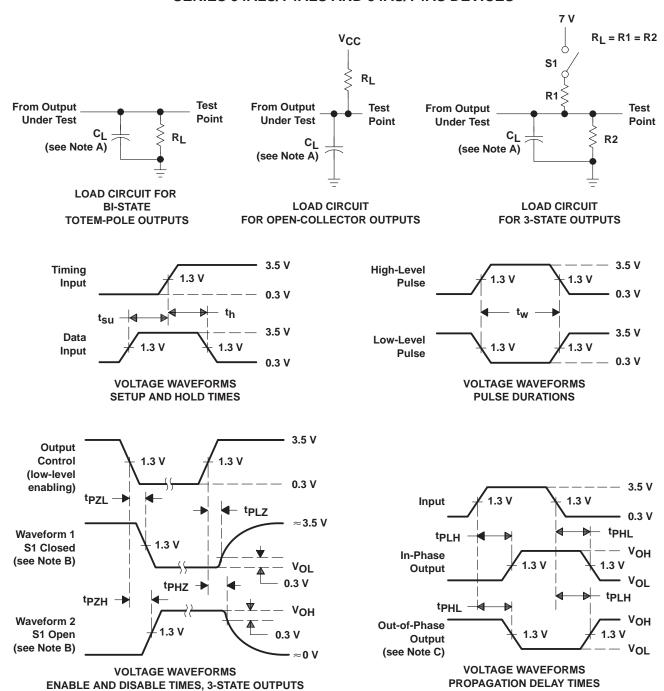
[¶] For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.



[†] All typical values are at V_{CC} = 5 V, T_A = 25°C. ‡ For I/O ports, the parameters I_{IH} and I_{IL} include the off-state output current.

[§] The output conditions have been chosen to produce a current that closely approximates one half of the true short-circuit output current, los.

PARAMETER MEASUREMENT INFORMATION SERIES 54ALS/74ALS AND 54AS/74AS DEVICES



- NOTES: A. C_L includes probe and jig capacitance.
 - B. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.
 - C. When measuring propagation delay items of 3-state outputs, switch S1 is open.
 - D. All input pulses have the following characteristics: PRR \leq 1 MHz, $t_f = t_f = 2$ ns, duty cycle = 50%.
 - E. The outputs are measured one at a time with one transition per measurement.

Figure 1. Load Circuits and Voltage Waveforms





7-Jun-2010

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN74ALS638A-1N	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS638A-1NE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS638A-1NSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS638A-1NSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS638A-1NSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS638AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS638ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS638ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS638ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS638ANSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS639ADW	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS639ADWE4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS639ADWG4	ACTIVE	SOIC	DW	20	25	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS639AN	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS639ANE4	ACTIVE	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Purchase Samples
SN74ALS639ANSR	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS639ANSRE4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74ALS639ANSRG4	ACTIVE	SO	NS	20	2000	Green (RoHS & no Sb/Br)	CU NIPDAU	Level-1-260C-UNLIM	Purchase Samples
SN74AS638AN	NRND	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Samples Not Available
SN74AS638ANE4	NRND	PDIP	N	20	20	Pb-Free (RoHS)	CU NIPDAU	N / A for Pkg Type	Samples Not Available
SN74AS639DW	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	Samples Not Available



PACKAGE OPTION ADDENDUM

7-.lun-2010

Orderable Device	Status (1) P	ackage Type	Package Drawing	Pins	Package Qty	Eco Plan ⁽²⁾	Lead/ Ball Finish	MSL Peak Temp ⁽³⁾	Samples (Requires Login)
SN74AS639DWR	OBSOLETE	SOIC	DW	20		TBD	Call TI	Call TI	Samples Not Available
SN74AS639N	OBSOLETE	PDIP	N	20		TBD	Call TI	Call TI	Samples Not Available

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check http://www.ti.com/productcontent for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. -- The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

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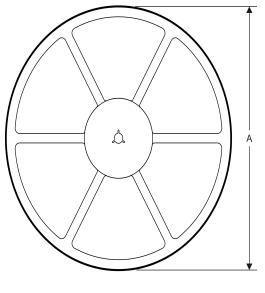
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PACKAGE MATERIALS INFORMATION

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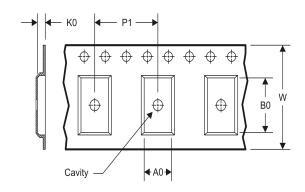
TAPE AND REEL INFORMATION

REEL DIMENSIONS





TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
В0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

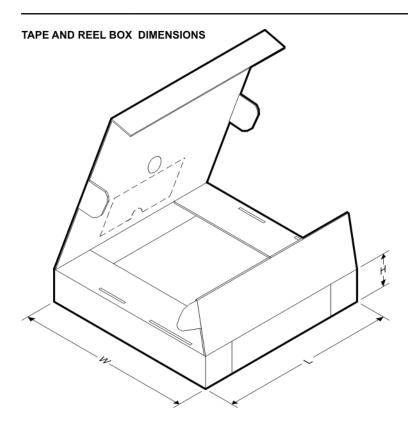
TAPE AND REEL INFORMATION

*All dimensions are nominal

Device	Package Type	Package Drawing		SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
SN74ALS638A-1NSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1
SN74ALS638ANSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1
SN74ALS639ANSR	SO	NS	20	2000	330.0	24.4	8.2	13.0	2.5	12.0	24.0	Q1

PACKAGE MATERIALS INFORMATION

www.ti.com 14-Jul-2012



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
SN74ALS638A-1NSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS638ANSR	SO	NS	20	2000	367.0	367.0	45.0
SN74ALS639ANSR	SO	NS	20	2000	367.0	367.0	45.0

N (R-PDIP-T**)

PLASTIC DUAL-IN-LINE PACKAGE

16 PINS SHOWN



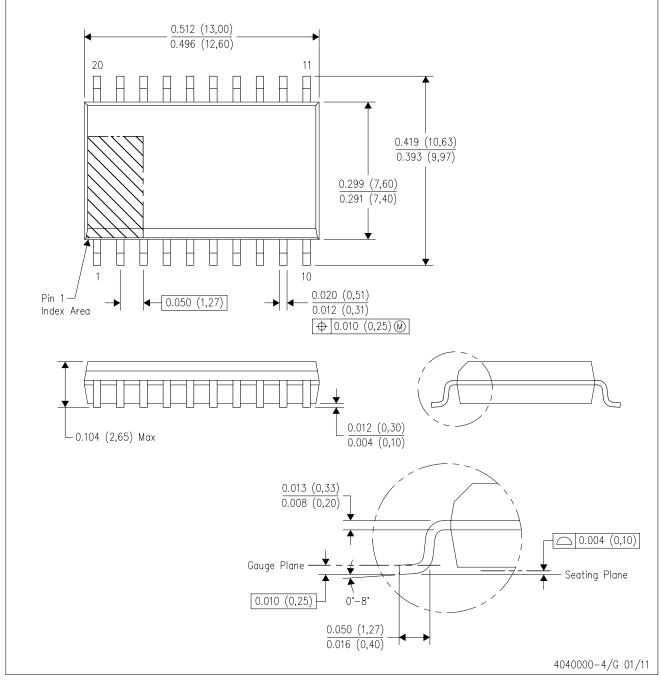
NOTES:

- A. All linear dimensions are in inches (millimeters).
- B. This drawing is subject to change without notice.
- Falls within JEDEC MS-001, except 18 and 20 pin minimum body length (Dim A).
- The 20 pin end lead shoulder width is a vendor option, either half or full width.



DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



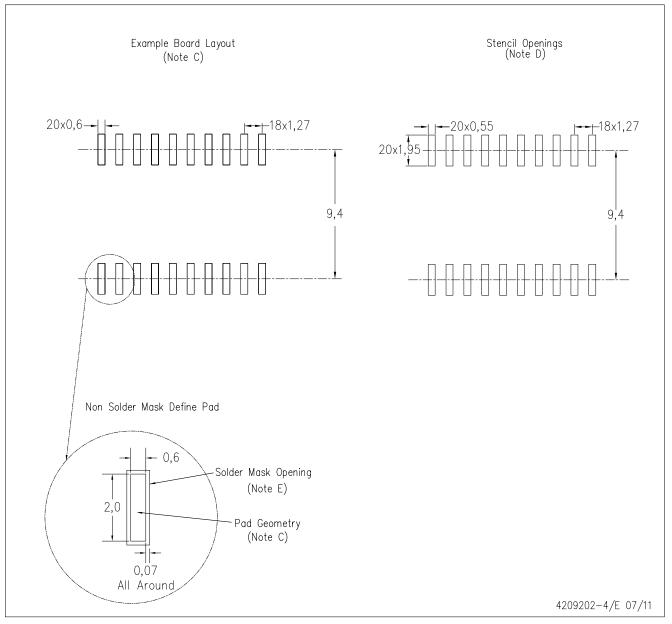
NOTES: A. All linear dimensions are in inches (millimeters). Dimensioning and tolerancing per ASME Y14.5M-1994.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0.006 (0,15).
- D. Falls within JEDEC MS-013 variation AC.



DW (R-PDSO-G20)

PLASTIC SMALL OUTLINE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Refer to IPC7351 for alternate board design.
- D. Laser cutting apertures with trapezoidal walls and also rounding corners will offer better paste release. Customers should contact their board assembly site for stencil design recommendations. Refer to IPC—7525
- E. Customers should contact their board fabrication site for solder mask tolerances between and around signal pads.



MECHANICAL DATA

NS (R-PDSO-G**)

14-PINS SHOWN

PLASTIC SMALL-OUTLINE PACKAGE



NOTES:

- A. All linear dimensions are in millimeters.
- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



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Only those TI components which TI has specifically designated as military grade or "enhanced plastic" are designed and intended for use in military/aerospace applications or environments. Buyer acknowledges and agrees that any military or aerospace use of TI components which have *not* been so designated is solely at the Buyer's risk, and that Buyer is solely responsible for compliance with all legal and regulatory requirements in connection with such use.

TI has specifically designated certain components which meet ISO/TS16949 requirements, mainly for automotive use. Components which have not been so designated are neither designed nor intended for automotive use; and TI will not be responsible for any failure of such components to meet such requirements.

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